APPLICA	BLE STAN	DARD										
Operating temperature		range	ange -55 °C to 125 °C ( <b>note 1</b> ) Stora		range				-10°C TO 60°C(Packed condition)			
RATING	Voltage		50V AC/DC		Operating or stor humidity range		ge	Re	Relative humidity 90 % MAX (Not de			
	Current		0.50 A Applica (FPC/F		table cable $t=0.3\pm0.05$ mm, Gold (Ground plate : Tin p		. 0					
			SPE	CIFICA	10ITA	NS						
IT	EM		TEST METHOD	)			RE	QUI	REMENTS	QT	АТ	
CONSTR	UCTION	ч										
General examination		Visually and by measuring instrument.				According to drawing.				×	×	
Marking		Confirme	d visually.			(note 2	2)			×	×	
ELECTRI	CAL CHA	RACTE	RISTICS									
Voltage proo	f	150 V AC	for 1 min.			No flas	hover or b	reak	down.	×	_	
Insulation res	sistance	100 V DC.				500 MΩ MIN.				×	_	
Contact resis	stance	AC 20 mV MAX , 1 mA .				100 m	Ω MAX.					
Contact resis	starice	AC 20 MV MAX , 1 MA .						-0 1	alle me eletemen	×	_	
						Including FPC/FFC bulk resistance (L=8mm(FPC) , 20mm(FFC))						
	IICAL CHA										1	
Vibration		Frequency 10 to 55 Hz, half amplitude 0.75 mm, for 10 cycles in 3 axial directions.				<ol> <li>No electrical discontinuity of 1 μs.</li> <li>Contact resistance: 100 mΩ MAX.</li> </ol>			×	-		
Shock		981 m/s <sup>2</sup> , duration of pulse 6 ms				<ul><li>② Contact resistance: 100 mΩ MAX.</li><li>③ No damage, crack and looseness of parts.</li></ul>			×	<u> </u>		
Mechanical c	neration	at 3 times in 3 both axial directions.				① Contact registence: 100 mg MAV			×	-		
Modrianicard	peration	10 times insertions and extractions.				<ol> <li>Contact resistance: 100 mΩ MAX.</li> <li>No damage, crack and looseness of parts.</li> </ol>				*		
FPC/FFC			d by applicable FPC/FFC.			Insertion force : Direction of insertion			×	_		
insertion/extr	action force	(Thickness of FPC/FFC shall be t=0.3mm at initial condition.)				(n : Number of contacts) 4+0.3×n N MAX (FPC/FFC) ( <i>note 3</i> ) 4+0.39×n N MAX (Shielded FFC) ( <i>note 3</i> )						
									ection of extraction			
							imber of c					
						`			X (FPC/FFC) (note 3)			
									(Shielded FFC) (note 3)			
FPC/FFC		Measured by applicable FPC/FFC. (Thickness of FPC/FFC shall be t=0.3mm				on of extra			×	_		
retention for	retention force		at initial condition.)				(n : Number of contacts) 18+0.05×n N MIN (FPC/FFC) ( <i>note4</i> )					
									(Shielded FFC) ( <i>note4</i> )			
ENVIRON	MENTAL	CHARA	ACTERISTICS			1				-1	I	
Rapid change		_	ture -40→+15 <sub>TO</sub> +35→+12	25→+15 <sub>TO</sub> +	+35°C	① Cor	ntact resist	tance	e: 100 mΩ MAX.	×	I —	
temperature		Time $30 \rightarrow 2 \text{ to } 3 \rightarrow 30 \rightarrow 2 \text{ to } 3 \text{ min}$				② Insulation resistance: 50 M $\Omega$ MIN.						
Domp boot (	Ctoody state)	Under 5 cycles.				③ No damage, crack and looseness of parts.						
Damp heat (	Sieduy State)	Exposed at 60±2 °C, Relative humidity 90 to 95 %, 96 h.								×	-	
Damp heat,c	Damp heat,cyclic		Exposed at -10 to +65 °c,				① Contact resistance: 100 mΩ MAX.				<del>  -</del>	
		Relative humidity 90 to 96 %, 10 cycles, TOTAL 240 h.				<ul> <li>② Insulation resistance: 1 MΩ MIN.         (At high humidity)</li> <li>③ Insulation resistance: 50 MΩ MIN.         (At dry)</li> <li>④ No damage, crack and looseness of parts</li> </ul>				×		
COUN	T DE	SCRIPTION	ON OF REVISIONS		DESIG	NED			CHECKED		TE	
<b>A</b> 1		DIS-	F-00006186		KN. KOBA	YASHI			HS. HIRAHARA	2020	20200615	
REMARK					APPRO		1		2019	0409		
						CHECK		ED HS. SAKAMOTO		2019	20190409	
						DESIGNED		ED	RT. IKEDA			
Unless otherwise specified, refer to IEC 60512.				DRAWN NM. YONEYAMA		2019	0409					
	· .			DF	PRAWING NO. ELC-388109-00			0-00	)			
AUDOSE ELECTRIC CO. LED			PART	T NO. FH63S-**S-0. 5S		H63S-**S-0. 5SH						
			U FOTDIO OO I TD		CODE	≣ NO.			CL580	Δ	1/2	
FORM HD0011			- ,									

	SPECIFICAT	IONS		
ITEM	TEST METHOD	REQUIREMENTS	QT	AT
Dry heat	Exposed at 125±2°C, 96 h.	① Contact resistance: 100 mΩ MAX.	×	_
Cold	Exposed at -55±3°C, 96 h.	② No damage, crack and looseness of parts	×	_
Sulphur dioxide [JIS C 60068-2-42	Exposed at 40±2 °C,  Relative humidity 80±5%  25±5 ppm for 96 h.	① Contact resistance: 100 mΩ MAX.	×	_
Solderability	Soldered at solder temperature, 245±3°C for immersion duration,3±0.3 sec.	A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.	×	_
Resistance to soldering heat	1) Reflow soldering: Peak TMP. 250 °C MAX. Reflow TMP. over 220 °C 60 to 90 sec. Number of reflow: 2 times 2) Soldering irons: TMP. 350±10 °C for 5±1 sec.	No deformation of case of excessive looseness of the terminals. ( <i>note 5</i> )	×	_

#### (note 1)



The heat resistant temperature when using FFC is 105°C.

When the heat resistant temperature of FPC/FFC is less than 125°C/105°C, the heat resistant temperature of FPC/FFC is applied.

# (note 2)

This product features bottom-contact point.

"One Action Lock" completes FPC/FFC lock just by inserting the FPC/FFC.

Do not operate the actuator when inserting the FPC/FFC.

#### (note 3)

Do not insert the FPC/FFC to this product at an angle.

#### (note 4)

Stabilize the FPC/FFC to PCB or something fixed, if pull-up or pull-down force is exepected to be applied to the FPC/FFC.

There's a case witch FPC/FFC retention force doesn't fulfill the value, because FPC/FFC specification affects the result of FPC/FFC retention force.

## (note 5)

Blisters which may be generated on the housing do not affect product performance.

### (note 6)

The occurrence and the length of whisker, and the performance deterioration caused by it are out of the scope of this specification

Note QT:	Qualification Test AT:Assurance Test X:Applicable Test	DRAWIN	IG NO.	ELC-388109-00-00		
HRS	SPECIFICATION SHEET	PART NO.	FH63S-**S-0. 5SH			
11.0	HIROSE ELECTRIC CO., LTD.	CODE NO		CL580	A	2/2